Vishay



Lead (Pb)-Bearing Thick Film, Rectangular Chip Resistors



FEATURES

HALOGEN FREE

- Stability $\Delta R/R = 1$ % for 1000 h at 70 °C
- Lead (Pb)-bearing termination plating on Ni barrier layer
- Metal glaze on high quality ceramic
- Halogen-free according to IEC 61249-2-21 definiton
- AEC-Q200 qualified, rev. C compliant

| STANDARD ELECTRICAL | | | SPECIFICATIONS | | | | | | | |
|---------------------|------|----------|---|---|-----------------------------------|---|-----------------------------------|-----------------|-----------------|--|
| MODEL | | SIZE | RATED DISSIPATION P ₇₀ | LIMITING ELEMENT VOLTAGE | TEMPERATURE COEFFICIENT | TOLERANCE | RESISTANCE RANGE | SERIES | | |
| | INCH | METRIC | W | U _{max.} AC/DC | ppm/K | /6 | Ω | | | |
| D10/CRCW0402 | 0402 | RR 1005M | 0.063 | 50 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | |
| | | | Zero-Ohm-Resistor: I | $R_{\text{max.}} = 20 \text{ m}\Omega,$ | $I_{\text{max.}} = 1.5 \text{ A}$ | | | | | |
| D11/CRCW0603 | 0603 | RR 1608M | 0.10 | 75 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | |
| | | | Zero-Ohm-Resistor: I | $R_{\text{max.}} = 20 \text{ m}\Omega,$ | $I_{\text{max.}} = 2.0 \text{ A}$ | | | | | |
| D12/CRCW0805 | 0805 | RR 2012M | 0.125 | 150 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | |
| | | | Zero-Ohm-Resistor: $R_{\text{max.}} = 20 \text{ m}\Omega$, $I_{\text{max.}} = 2.5 \text{ A}$ | | | | | | | |
| D25/CRCW1206 | 1206 | RR 3216M | 0.25 | 200 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | |
| | | | Zero-Ohm-Resistor: I | $R_{\text{max.}} = 20 \text{ m}\Omega,$ | $I_{\text{max.}} = 3.5 \text{ A}$ | | | | | |
| CRCW1210 | 1210 | RR 3225M | 0.50 | 200 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | |
| | | | Zero-Ohm-Resistor: $R_{\text{max.}} = 20 \text{ m}\Omega$, $I_{\text{max.}} = 5.0 \text{ A}$ | | | | | | | |
| CRCW1218 | 1218 | 1218 | RR 3246M | 1.0 | 200 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 2M2 | E24; E96 E24 | |
| | | | Zero-Ohm-Resistor: I | Zero-Ohm-Resistor: $R_{\text{max.}} = 20 \text{ m}\Omega$, $I_{\text{max.}} = 7.0 \text{ A}$ | | | | | | |
| CRCW2010 | 2010 | RR 5025M | 0.75 | 400 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | |
| | | | Zero-Ohm-Resistor: $R_{\text{max.}} = 20 \text{ m}\Omega$, $I_{\text{max.}} = 6.0 \text{ A}$ | | | | | | | |
| CRCW2512 | 2512 | RR 6332M | 1.0 | 500 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | |
| | | | | | Zero-Ohm-Resistor: I | $R_{\text{max.}} = 20 \text{ m}\Omega,$ | $I_{\text{max.}} = 7.0 \text{ A}$ | | | |

Notes

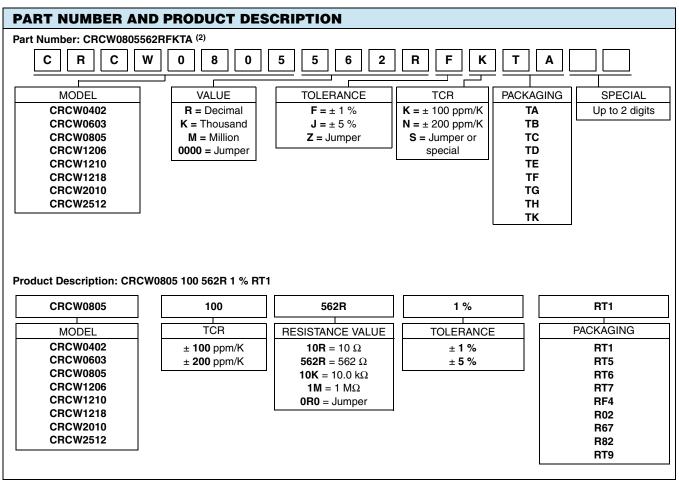
- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over
 operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- Marking: See datasheet "Surface Mount Resistor Marking" (document number 20020).
- · Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.



| TECHNICAL SPECIFICATIONS | | | | | | | | | |
|--|------|------------------|--------------------------|------------------|------------------|----------|----------|----------|----------|
| PARAMETER | UNIT | D10/ CRCW0402 | D11/ CRCW0603 | D12/ CRCW0805 | D25/ CRCW1206 | CRCW1210 | CRCW1218 | CRCW2010 | CRCW2512 |
| Rated dissipation at 70 °C (1) | W | 0.063 | 0.1 | 0.125 | 0.25 | 0.5 | 1.0 | 0.75 | 1.0 |
| Limiting element voltage $U_{\mathrm{MAX.}}$ AC/DC | ٧ | 50 | 75 | 150 | 200 | 200 | 200 | 400 | 500 |
| Insulation voltage $U_{\rm INS.}$ (1 min) | ٧ | > 75 | > 100 | > 200 | > 300 | > 300 | > 300 | > 300 | > 300 |
| Insulation resistance | Ω | | > 10 ⁹ | | | | | | |
| Category temperature range °C - 55 to + 155 | | | | | | | | | |
| Failure rate | h-1 | | < 0.1 x 10 ⁻⁹ | | | | | | |
| Weight | mg | 0.65 | 2 | 5.5 | 10 | 16 | 29.5 | 25.5 | 40.5 |

Note

⁽¹⁾ The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.



Note

⁽²⁾ Preferred way for ordering products is by use of the PART NUMBER.

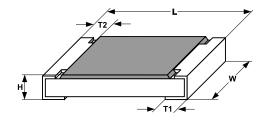
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Lead (Pb)-Bearing Thick Film, Rectangular Chip Resistors



| PACKAGING | | | | | | | | |
|---------------|---------------|----------|-------------------------------|---------------|---|-------------|---------------|--|
| MODEL | UNIT | | PAPER TAP ACC. IEC 60286-3 | _ | BLISTER TAPE ACC. IEC 60286-3, TYPE II | | | |
| | | QUANTITY | PART NUMBER | PRODUCT DESC. | QUANTITY | PART NUMBER | PRODUCT DESC. | |
| D10/CRCW0402 | 180 mm/7" | 10 000 | TD | RT7 | | | | |
| D10/ChCVV0402 | 330 mm/13" | 50 000 | TE | RF4 | | | | |
| | 180 mm/7" | 5000 | TA | RT1 | | | | |
| D11/CRCW0603 | 285 mm/11.25" | 10 000 | ТВ | RT5 | | | | |
| | 330 mm/13" | 20 000 | TC | RT6 | | | | |
| | 180 mm/7" | 5000 | TA | RT1 | | | | |
| D12/CRCW0805 | 285 mm/11.25" | 10 000 | ТВ | RT5 | | | | |
| | 330 mm/13" | 20 000 | TC | RT6 | | | | |
| | 180 mm/7" | 5000 | TA | RT1 | | | | |
| D25/CRCW1206 | 285 mm/11.25" | 10 000 | ТВ | RT5 | | | | |
| | 330 mm/13" | 20 000 | TC | RT6 | | | | |
| | 180 mm/7" | 5000 | TA | RT1 | | | | |
| CRCW1210 | 285 mm/11.25" | 10 000 | ТВ | RT5 | | | | |
| | 330 mm/13" | 20 000 | TC | RT6 | | | | |
| CRCW1218 | 180 mm/7" | | | | 4000 | TK | RT9 | |
| CRCW2010 | 180 mm/7" | | | | 4000 | TF | R02 | |
| CDCW0E10 | 180 mm/7" | | | | 2000 | TG | R67 | |
| CRCW2512 | 100 111111/7 | | | | 4000 | TH | R82 | |

DIMENSIONS





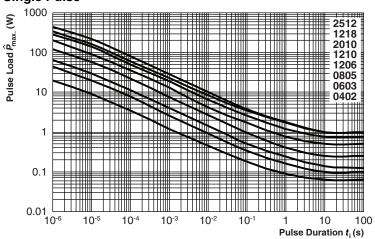
| SIZE | | DIMENSIONS in millimeters | | | | | SOLDER PAD DIMENSIONS in millimeters | | | | | |
|------|--------|---------------------------|----------------|-----------------|-------------------|---------------|--------------------------------------|-----|-----|----------------|-----|-----|
| | | | | | | | REFLOW SOLDERING | | | WAVE SOLDERING | | |
| INCH | METRIC | L | w | Н | T1 | T2 | а | b | I | а | b | I |
| 0402 | 1005 | 1.0 ± 0.05 | 0.5 ± 0.05 | 0.35 ± 0.05 | 0.25 ± 0.05 | 0.2 ± 0.1 | 0.4 | 0.6 | 0.5 | | | |
| 0603 | 1608 | 1.55 + 0.10 | 0.85 ± 0.1 | 0.45 ± 0.05 | 0.3 ± 0.2 | 0.3 ± 0.2 | 0.5 | 0.9 | 1.0 | 0.9 | 0.9 | 1.0 |
| 0805 | 2012 | 2.0 + 0.20 - 0.10 | 1.25 ± 0.15 | 0.45 ± 0.05 | 0.3 + 0.20 - 0.10 | 0.3 ± 0.2 | 0.7 | 1.3 | 1.2 | 0.9 | 1.3 | 1.3 |
| 1206 | 3216 | 3.2 + 0.10 - 0.20 | 1.6 ± 0.15 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 1.7 | 2.0 | 1.1 | 1.7 | 2.3 |
| 1210 | 3225 | 3.2 ± 0.2 | 2.5 ± 0.2 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 2.5 | 2.0 | 1.1 | 2.5 | 2.2 |
| 1218 | 3246 | 3.2 + 0.10 | 4.6 ± 0.15 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 1.05 | 4.9 | 1.9 | 1.25 | 4.8 | 1.9 |
| 2010 | 5025 | 5.0 ± 0.15 | 2.5 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 2.5 | 3.9 | 1.2 | 2.5 | 3.9 |
| 2512 | 6332 | 6.3 ± 0.2 | 3.15 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 3.2 | 5.2 | 1.2 | 3.2 | 5.2 |

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Document Number: 20008
Revision: 18-Nov-10



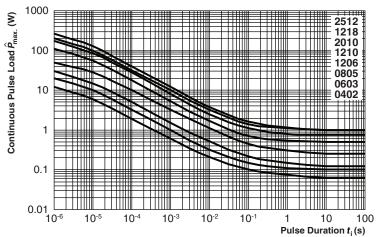
FUNCTIONAL PERFORMANCE

Single Pulse



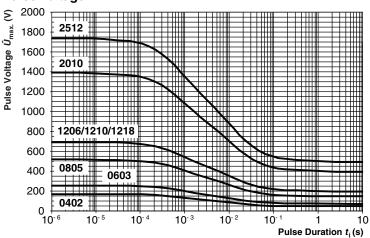
Maximum pulse load, single pulse; applicable if $\bar{P} \longrightarrow 0$ and n < 1000 and $\hat{U} \le \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

Continuous Pulse



Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P$ (θ_{amb}) and $\hat{U} \leq \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

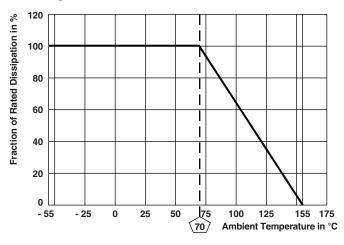
Pulse Voltage



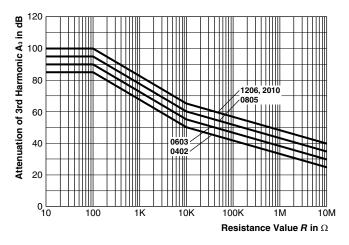
Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max}$; for permissible resistance change equivalent to 8000 h operation



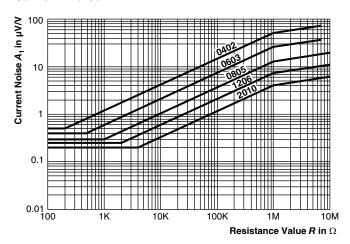
Derating



Non-Linearity



Current Noise



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| | | | BD0053::25 | REQUIREMENTS PERMISSIBLE CHANGE ($\triangle R$) | | | |
|---------------|----------------------|--|--|---|---|--|--|
| EN 60115-1 | IEC 60082-2 | TEST | PROCEDURE | STABILITY CLASS 1 OR BETTER | STABILITY CLASS 2 OR BETTER | | |
| CLAUSE | TEST METHOD | | Stability for product types: | | | | |
| | | | D/CRCW | 1 Ω to 10 MΩ | 1 Ω to 10 M Ω | | |
| 4.5 | - | Resistance | <u> </u> | ± 1 % | ± 5 % | | |
| 4.7 | - | Voltage proof | $U = 1.4 \cdot U_{\text{ins;}} 60 \text{ s}$ | No flashover | | | |
| 4.13 | - | Short time overload | $U = 2.5 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}};$ duration: Acc. to style | ± (0.25 % R + 0.05 Ω) | ± (0.5 % R + 0.05 Ω) | | |
| 4.17.2 | 58 (Td) | Solderability | Solder bath method; Sn60Pb40; non-activated flux; (235 ± 5) °C, (2 ± 0.2) s | Good tinning (≥ 95 % covered); no visible damage | | | |
| 4.8.4.2 | 1 | Temperature coefficient | (20/- 55/20) °C and (20/125/20) °C | ± 100 ppm/K | ± 200 ppm/K | | |
| 4.32 | 21 (Uu ₃₎ | Shear (adhesion) | RR 1608 and smaller: 9 N RR 2012 and larger: 45 N | No visible | e damage | | |
| 4.33 | 21 (Uu ₁₎ | Substrate bending | Depth 2 mm; 3 times | no open circuit | sible damage, cuit in bent position % R + 0.05 Ω) | | |
| 4.19 | 14 (Na) | Rapid change of temperature | 30 min. at - 55 °C; 30 min. at 125°C 5 cycles 1000 cycles | ± (0.25 % R + 0.05 Ω) ± (1 % R + 0.05 Ω) | ± (0.5 % R + 0.05 Ω) ± (1 % R + 0.05 Ω) | | |
| 4.23 | - | Climatic sequence: | - | | | | |
| 4.23.2 | 2 (Ba) | Dry heat | 125 °C; 16 h | | | | |
| 4.23.3 | 30 (Db) | Damp heat, cyclic | 55 °C; ≥ 90 % RH; 24 h; 1 cycle | | | | |
| 4.23.4 | 1 (Aa) | Cold | - 55 °C; 2 h | ± (1 % R + 0.05 Ω) | ± (2 % R + 0.1 Ω) | | |
| 4.23.5 | 13 (M) | Low air pressure | 1 kPa; (25 ± 10) °C; 1 h | | | | |
| 4.23.6 | 30 (Db) | Damp heat, cyclic | 55 °C; ≥ 90 % RH; 24 h; 5 cycles | | | | |
| 4.23.7 | - | DC load | $U = \sqrt{P_{70} \times R}$ | | 1 | | |
| 4.25.1 | - | Endurance at 70 °C | $U = \sqrt{(P_{70} \times R)} \le U_{\text{max.}}$ 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h | ± (1 % R + 0.05 Ω) ± (2 % R + 0.1 Ω) | ± (2 % R + 0.1 Ω) ± (4 % R + 0.1 Ω) | | |
| 4.18.2 | 58 (Td) | Resistance to soldering heat | Solder bath method (260 \pm 5) °C; (10 \pm 1) s | ± (0.25 % R + 0.05 Ω) | ± (0.5 % R + 0.05 Ω) | | |
| 4.35 | - | Flamability, needle flame test | IEC 60695-11-5; 10 s | No burning after 30 s | | | |
| 4.24 | 78 (Cab) | Damp heat, steady state | (40 ± 2) °C; (93 ± 3) % RH; 56 days | ± (1 % R + 0.05 Ω) | | | |
| 4.25.3 | - | Endurance at upper category temperature | 155 °C; 1000 h | ± (1 % R + 0.05 Ω) | ± (2 % R + 0.1 Ω) | | |
| 4.40 | - | Electrostatic discharge (human body model) | IEC 61340-3-1; 3 pos. + 3 neg. discharges; ESD test voltage acc. to size | ± (1 % <i>R</i> + 0.05 Ω) | | | |
| 4.29 | 45 (XA) | Component solvent resistance | Isopropyl alcohol; 50 °C; method 2 | No visible damage | | | |
| 4.30 | 45 (XA) | Solvent resistance of marking | Isopropyl alcohol; 50 °C; method 1, toothbrush | Marking legible, no visible damage | | | |

D/CRCW

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Lead (Pb)-Bearing Thick Film, Rectangular Chip Resistors



| TEST F | TEST PROCEDURES AND REQUIREMENTS | | | | | | | | | | |
|---------------|----------------------------------|---|---|--|--------------------------------|--|--|--|--|--|--|
| | | | PROCEDURE | REQUIREMENTS PERMISSIBLE CHANGE (ΔR) | | | | | | | |
| EN 60115-1 | IEC 60082-2 TEST | TEST | PROCEDURE | STABILITY CLASS 1 OR BETTER | STABILITY CLASS 2 OR BETTER | | | | | | |
| CLAUSE | METHOD | | Stability for product types: | 1 Ω to 10 MΩ | 1 Ω to 10 MΩ | | | | | | |
| | | | D/CRCW | 1 22 10 10 10122 | | | | | | | |
| 4.22 | 6 (Fc) | Vibration, endurance by sweeping | f = 10 Hz to 2000 Hz; x, y, z \leq 1.5 mm; A \leq 200 m/s ² ; 10 sweeps per axis | $\pm (0.25 \% R + 0.05 \Omega)$ | ± (0.5 % R + 0.05 Ω) | | | | | | |
| 4.37 | - | Periodic electric overload | $U = \sqrt{15 \times P_{70} \times R} \le 2 \times U_{\text{max.}};$ 0.1 s on; 2.5 s off; 1000 cycles | ± (1 % <i>R</i> + 0.05 Ω) | | | | | | | |
| 4.27 | - | Single pulse high voltage overload, 10 μs/700 μs | $\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}};$ 10 pulses | ± (1 % R + 0,05 Ω) | | | | | | | |

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.

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